

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|----------|--|--|------------------|---------|------------------|
| L1 | 590 | 438/123,901,271,399,738,386.ccor. | US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB | OR | ON | 2005/08/01 12:57 |
| L2 | 459 | 438/123,901,271,399,738,386.ccor. and @ad<"20021002" | US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB | OR | ON | 2005/08/01 12:57 |
| S89 | 14039115 | semiconductor and sacrificial and supporting and electrode @ad<="20021002" | US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB | OR | ON | 2005/07/29 16:55 |
| S90 | 70 | @ad<="20021002" and (pattern\$3 near4 (sacrific\$3 adj layer)) and ((wet adj etch) near8 (sacrific\$3)) | US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB | OR | ON | 2005/08/01 09:57 |
| S91 | 5 | @ad<="20021002" and (pattern\$3 near4 (sacrific\$3 adj layer)) and ((wet adj etch) near8 (sacrific\$3)) and (sacrific\$3 near5 (HSQ BPSG PSG)) | US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB | OR | ON | 2005/08/01 11:41 |
| S92 | 34 | @ad<="20021002" and ((opening hole) near3 (sacrific\$3 adj layer)) and ((wet adj etch) near8 (sacrific\$3)) | US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB | OR | ON | 2005/08/01 10:39 |
| S93 | 5 | @ad<="20021002" and (pattern\$3 near4 (sacrific\$3 adj layer)) and ((wet adj etch) near8 (sacrific\$3)) and (sacrific\$3 near5 (HSQ BPSG PSG)) | US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB | OR | ON | 2005/08/01 09:58 |
| S94 | 32 | S92 not S93 | US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB | OR | ON | 2005/08/01 10:10 |
| S95 | 70 | @ad<="20021002" and (pattern\$3 near4 (sacrific\$3 adj layer)) and ((wet adj etch) near8 (sacrific\$3)) | US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB | OR | ON | 2005/08/01 10:30 |
| S96 | 11 | S92 not S95 | US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB | OR | ON | 2005/08/01 10:10 |

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|----------|----|--|---|----|----|------------------|
| S97 | 82 | @ad<="20021002" and (pattern\$3 near6 (sacrific\$3 adj layer)) and ((wet adj etch) near8 (sacrific\$3)) | US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB | OR | ON | 2005/08/01 10:30 |
| S98 | 12 | S97 not S95 | US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB | OR | ON | 2005/08/01 10:31 |
| S99 | 98 | @ad<="20021002" and ((pattern\$3 opening hole) near5 (sacrific\$3 adj layer)) and ((wet adj etch) near8 (sacrific\$3)) | US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB | OR | ON | 2005/08/01 10:39 |
| S10 0 | 28 | S99 not S95 | US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB | OR | ON | 2005/08/01 10:40 |
| S10 1 | 17 | S100 not S92 | US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB | OR | ON | 2005/08/01 10:40 |
| S10 2 | 2 | "20040009662" | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/01 11:00 |
| S10 3 | 34 | @ad<="20021002" and ((sacrific\$3 near5 (HSQ BPSG PSG)) and (PETEOS HDP (high adj density and plasma))) | US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB | OR | ON | 2005/08/01 11:45 |
| S10 4 | 15 | @ad<="20021002" and ((sacrific\$3 near5 (HSQ BPSG PSG)) and (PETEOS HDP (high adj density adj plasma))) | US-PGPUB; USPAT; USOCR; DERWENT; IBM_TDB | OR | ON | 2005/08/01 12:57 |